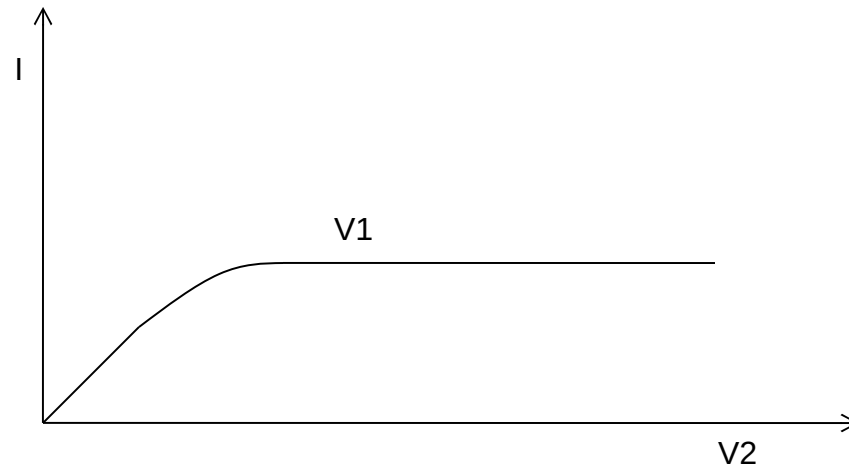
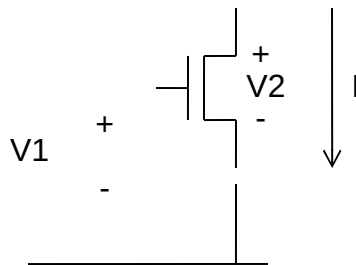
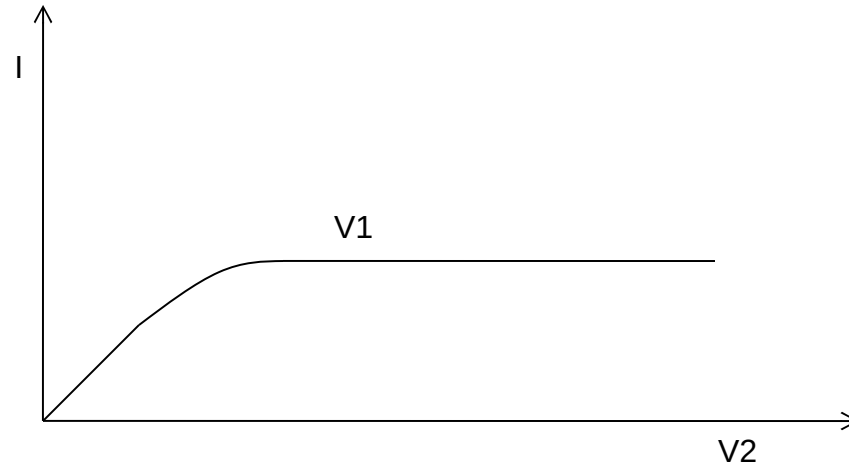
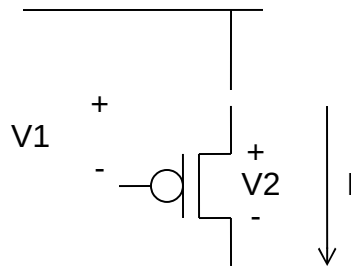
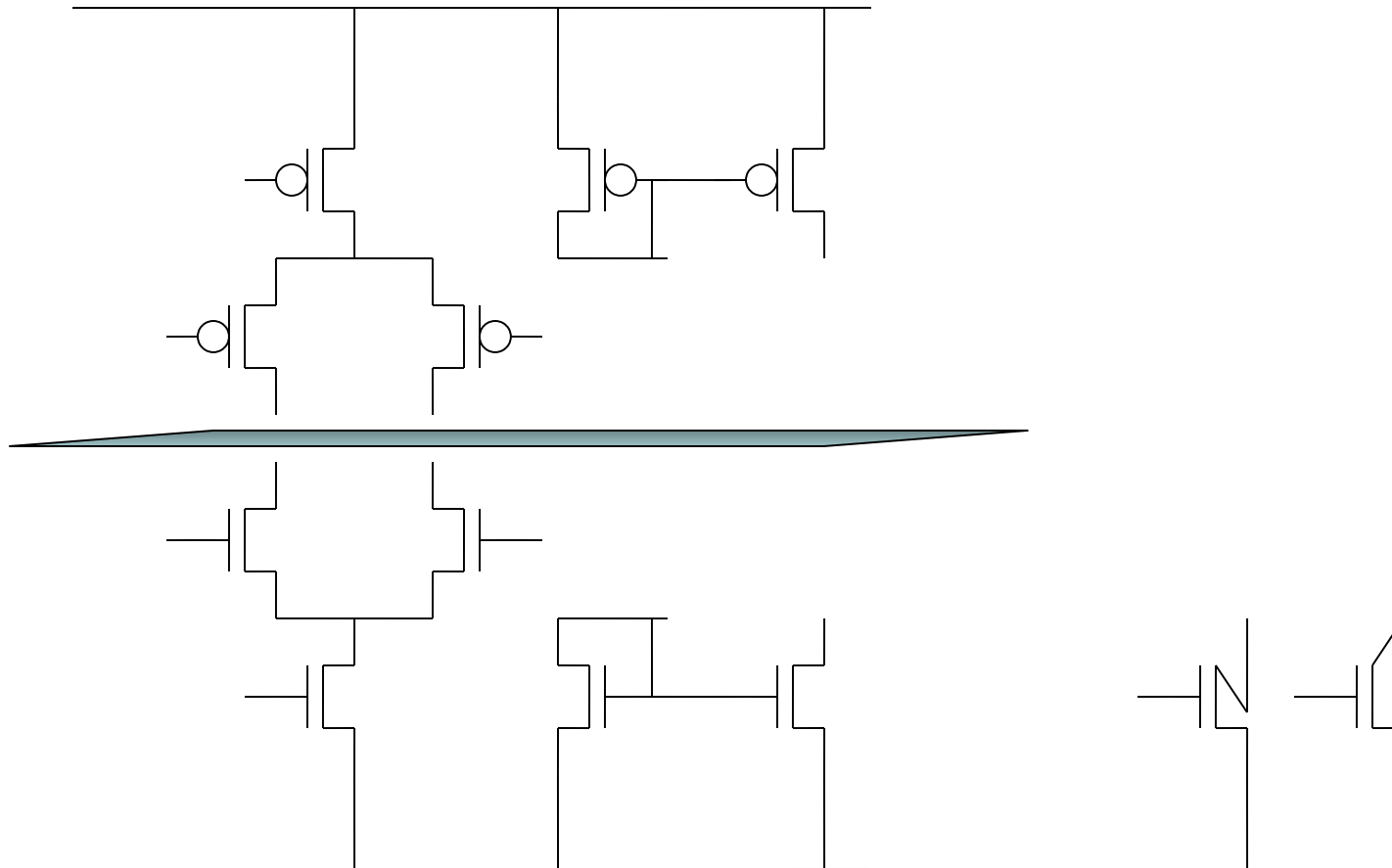


Vorlesung 5

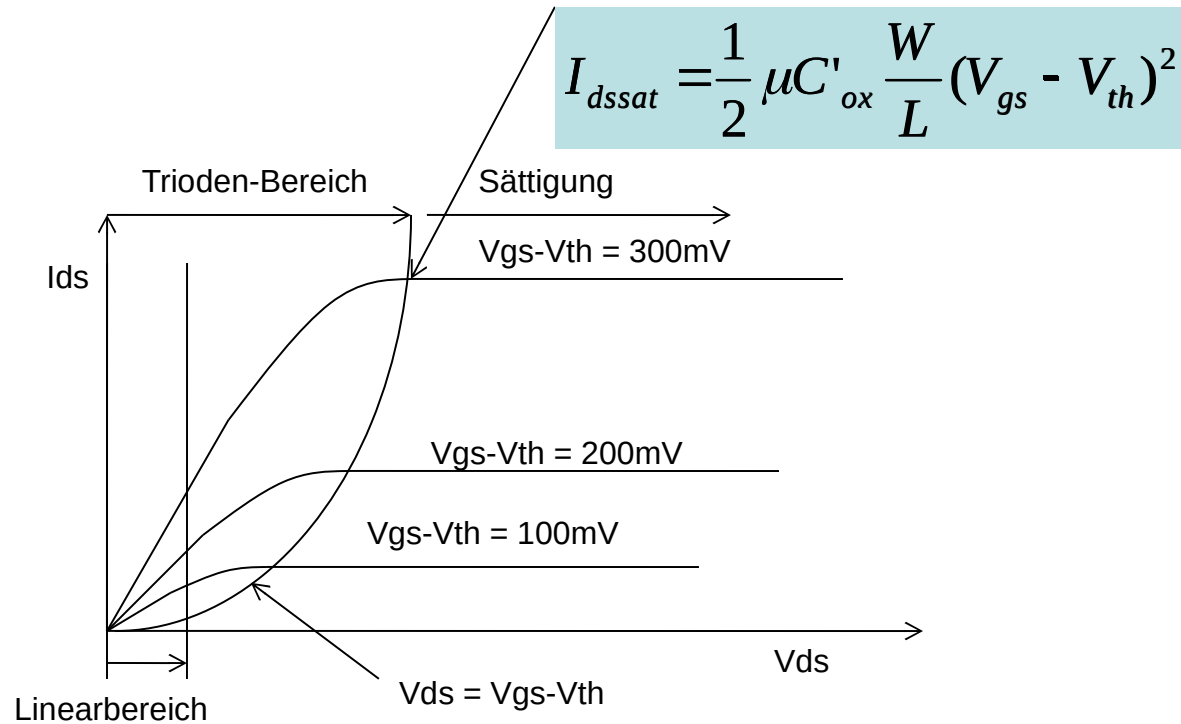
- PMOS und NMOS Kennlinien sind gleich aber die Indizes bei den Spannungen und Strömen sollen vertauscht werden



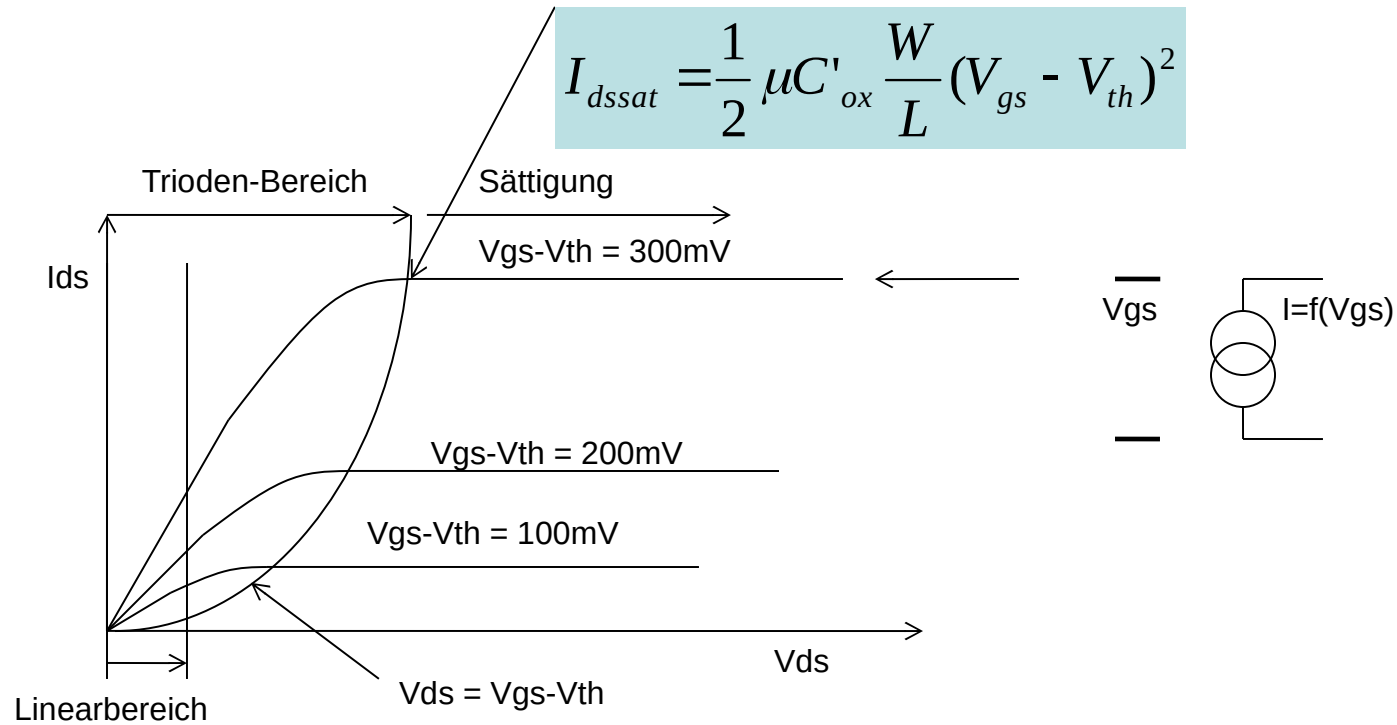
- NMOS und PMOS Schaltungen sind in der Regel Spiegelsymmetrisch
- Ströme fließen von oben nach unten



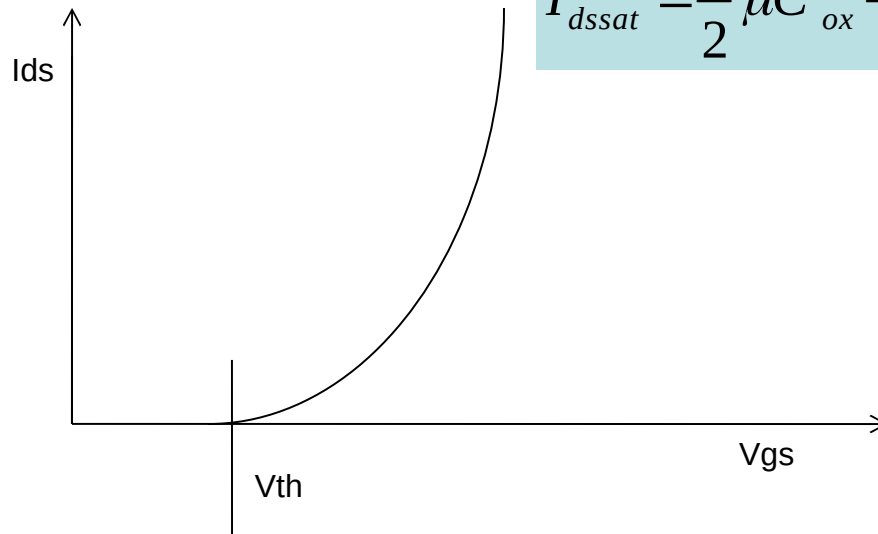
- Zwei Spannungen – Vgs und Vds und zwei Ströme Ids und Igs (Igs = 0)
- Ids als Funktion von Vds für verschiedene Vgs (Ausgangskennlinien)



- Sättigung: Strom von Vds praktisch unabhängig - Stromquelle

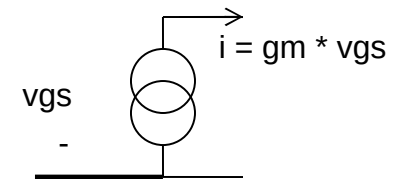
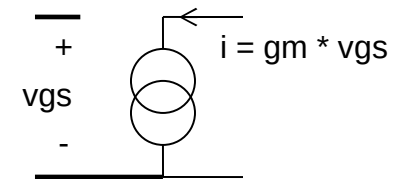
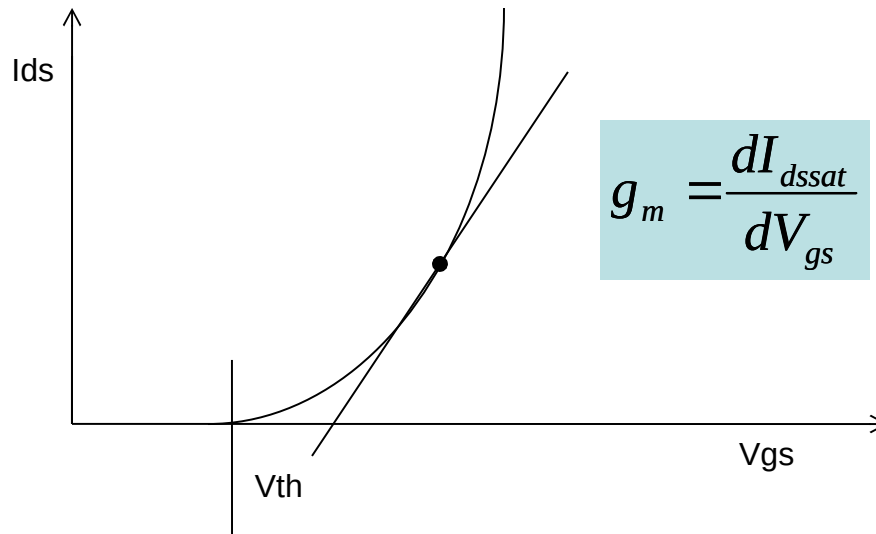


- ...



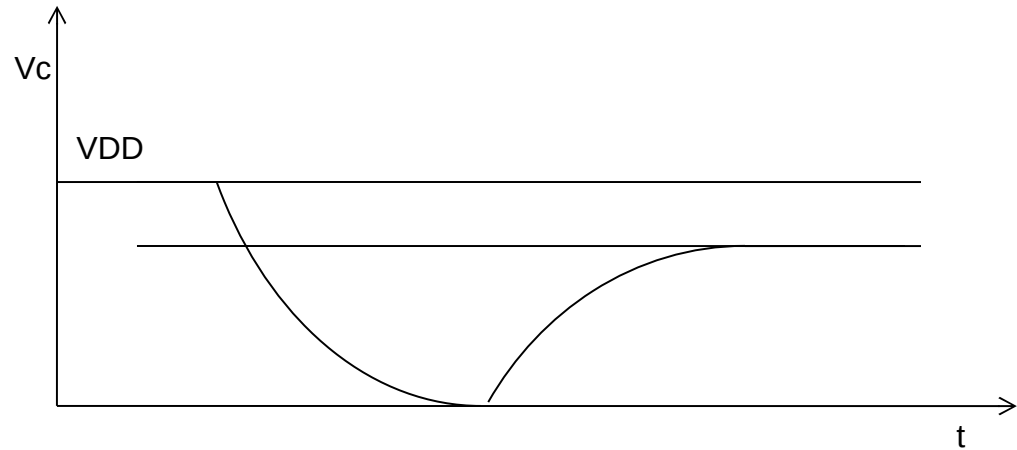
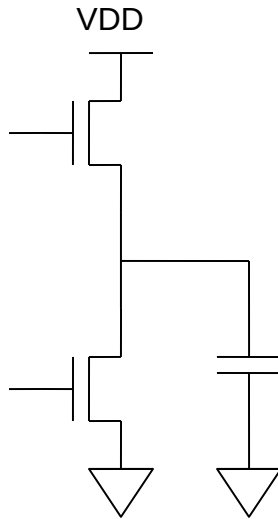
$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} - V_{th})^2$$

- Die Eingangskennlinie wird im Bereich um den Arbeitspunkt linearisiert -> Kleinsignalmodell

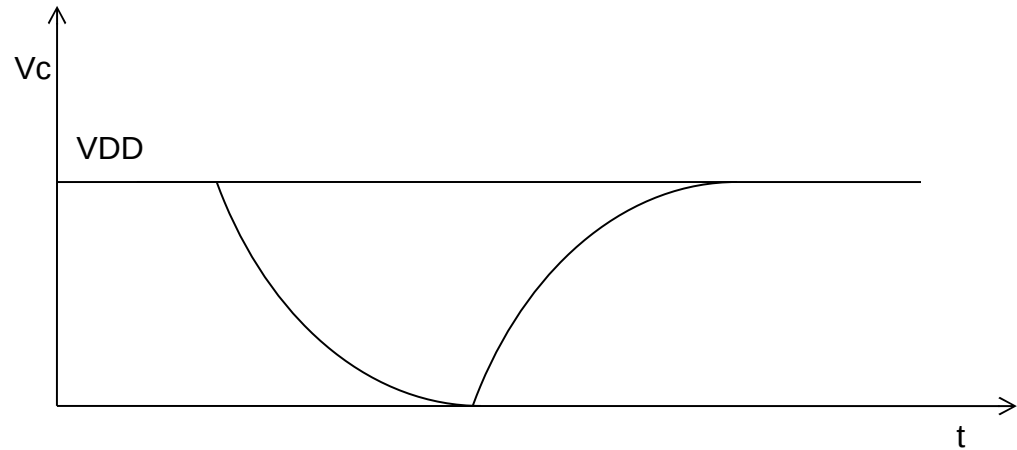
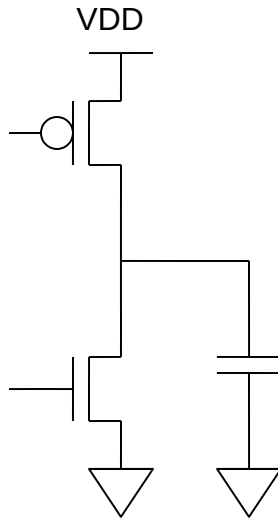


+

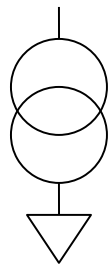
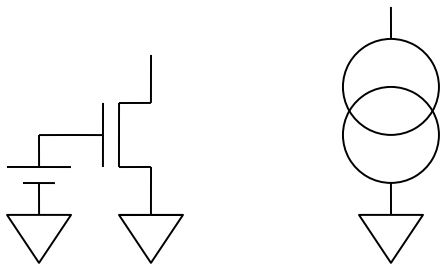
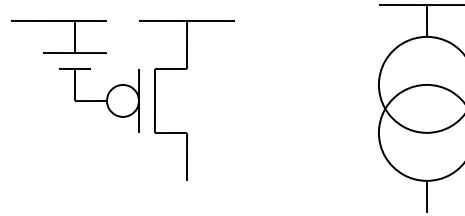
- NMOS



- PMOS

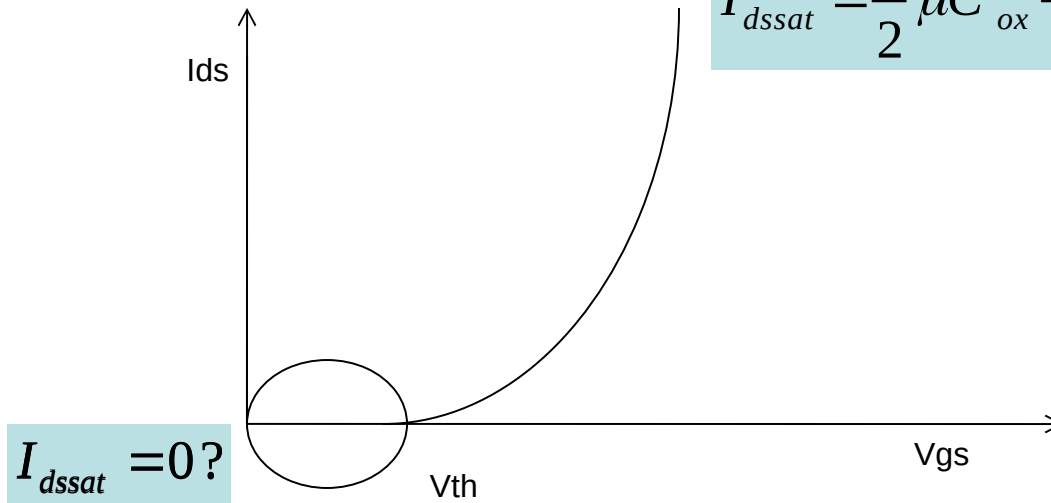


- Stromquellen

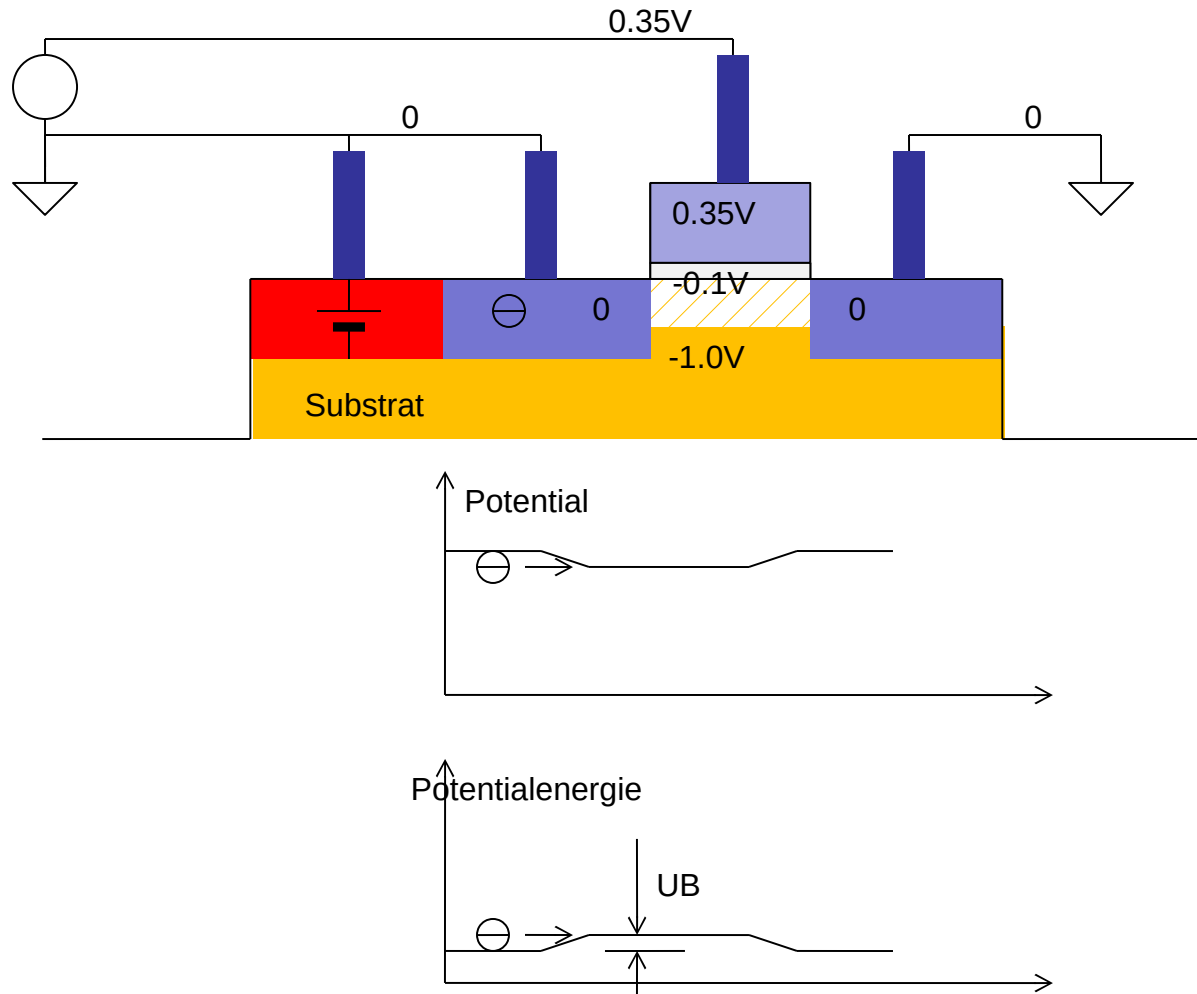


- Transistor

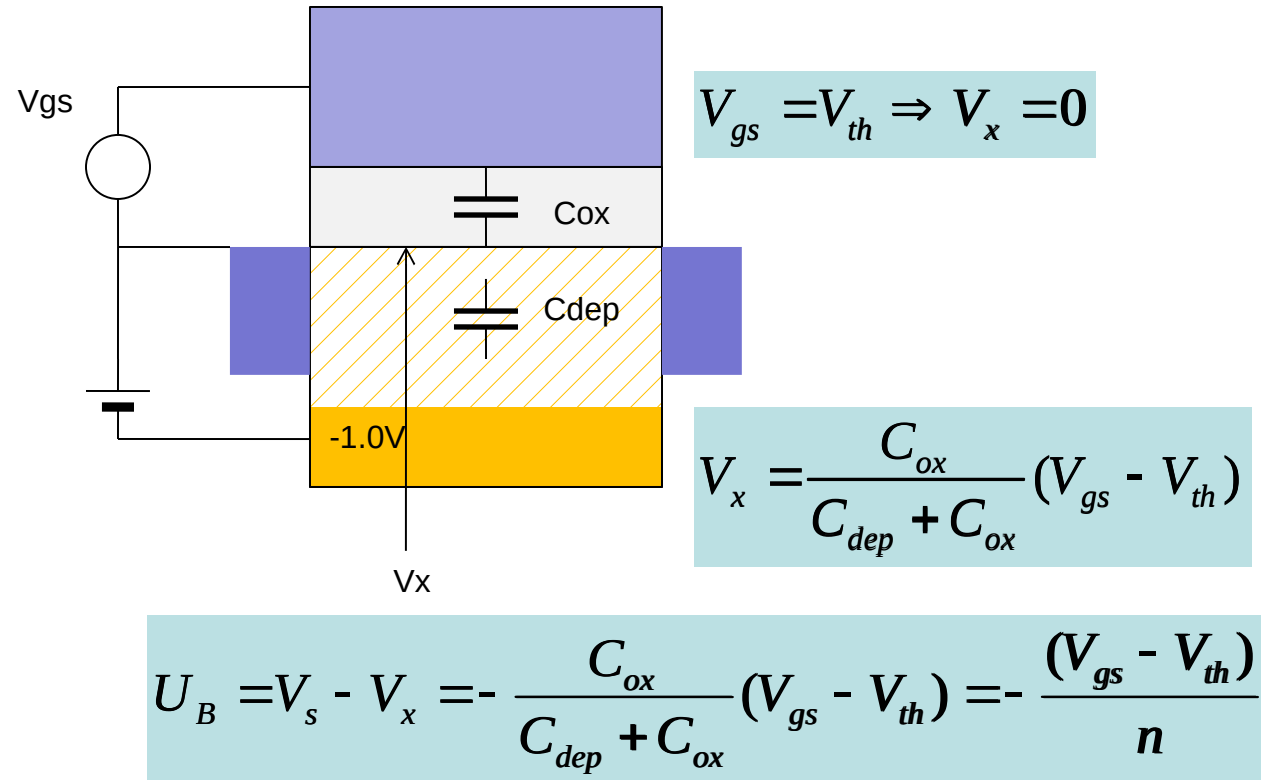
$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} - V_{th})^2$$



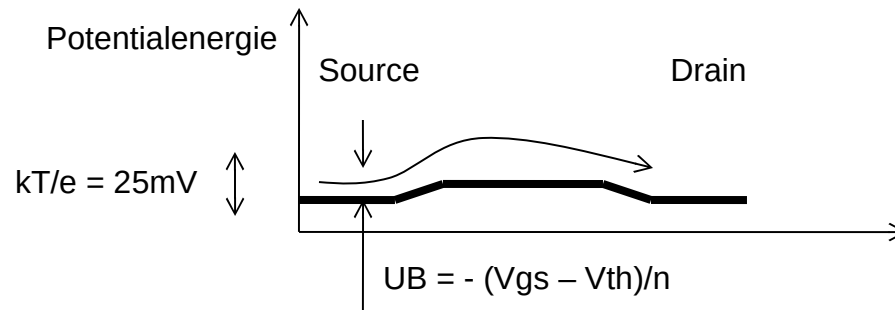
- Transistor



- Transistor

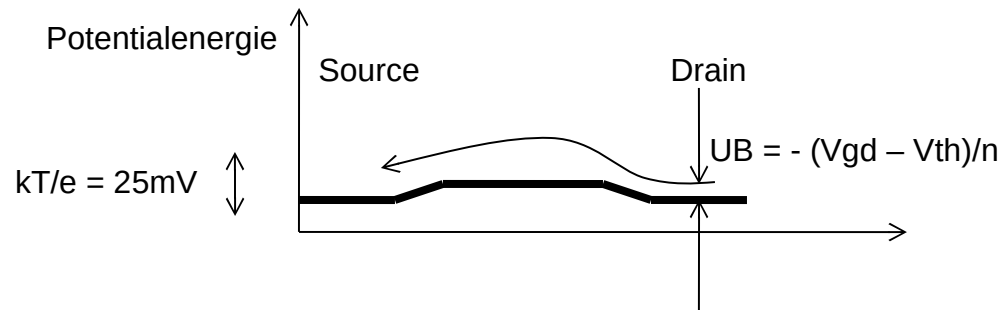


- Transistor



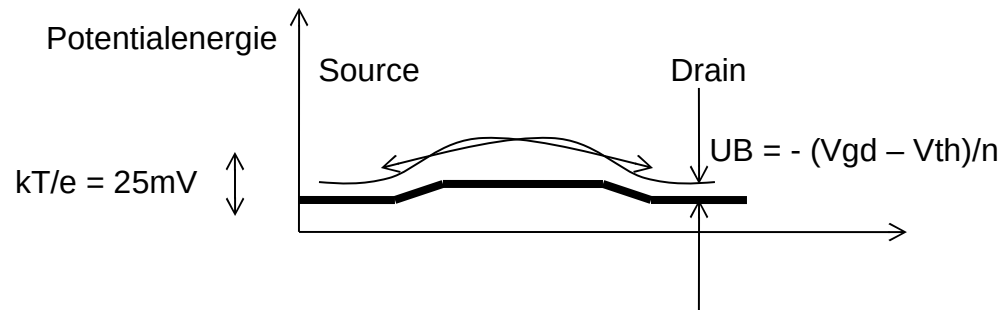
$$\Phi_{sd} = \text{const} \cdot e^{-U_B/U_T} = \text{const} \cdot e^{(V_{gs} - V_{th})/nU_T}$$

- Transistor



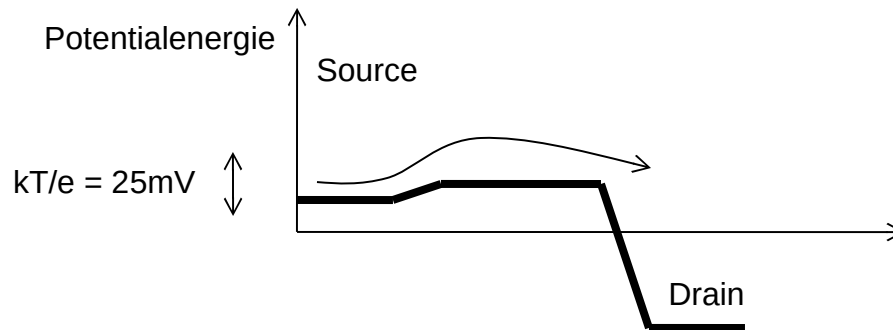
$$\Phi_{ds} = \text{const} \cdot e^{-U_B/U_T} = \text{const} \cdot e^{(V_{gd} - V_{th})/nU_T}$$

- Transistor



$$I_{ds} = e(\Phi_{sd} - \Phi_{ds}) = 0$$

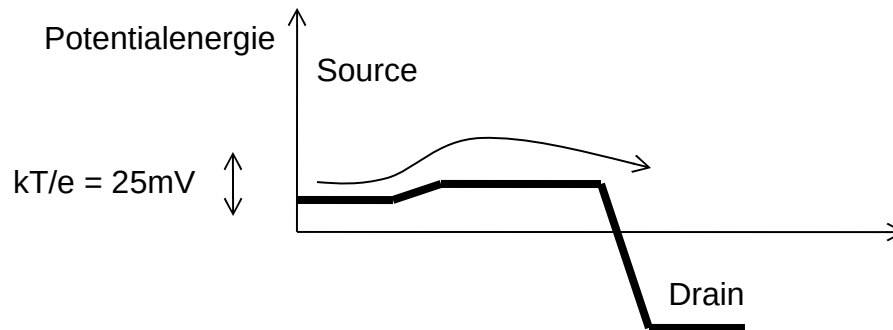
- Transistor



$$I_{ds} = \text{const} \cdot \left(e^{(V_{gs} - V_{th})/nU_T} - e^{(V_{gd} - V_{th})/nU_T} \right)$$

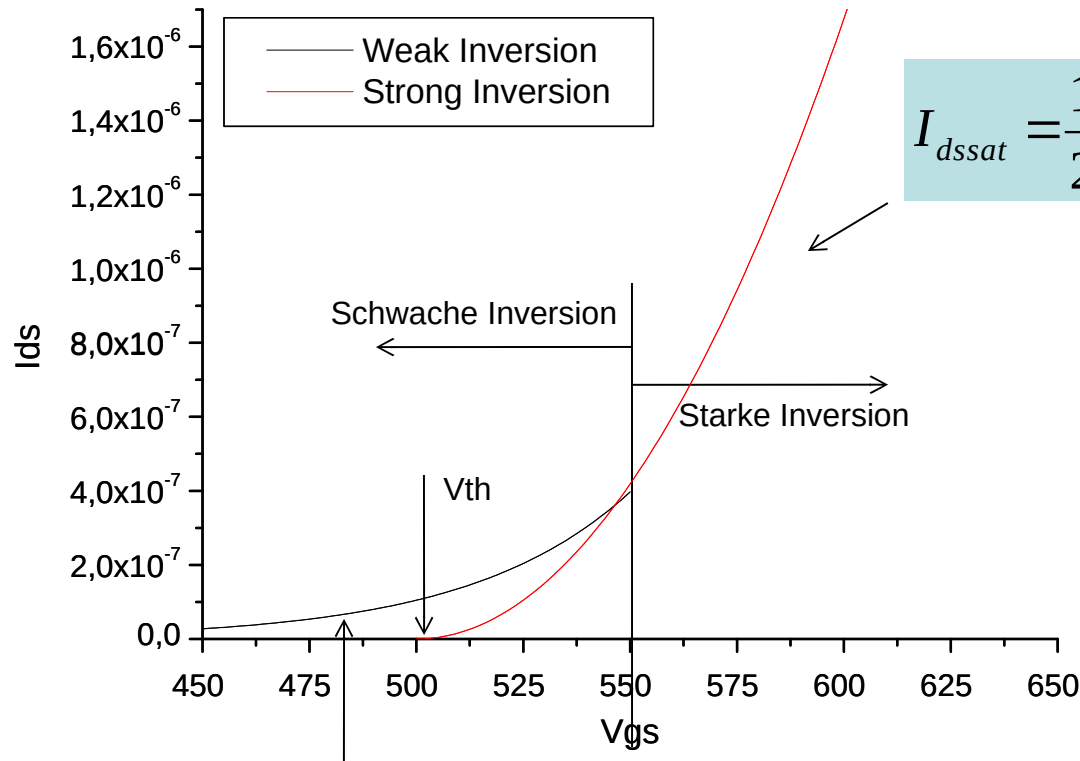
$$I_{ds} = \text{const} \cdot e^{(V_{gs} - V_{th})/nU_T} \left(1 - e^{-V_{ds}/nU_T} \right)$$

- Transistor



$$I_{dssat} = \frac{W}{L} \cdot C'_{ox} U_T^2 \cdot (n - 1) \cdot e^{(V_{gs} - V_{th})/nU_T}$$

- Transistor



$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} - V_{th})^2$$

$$I_{dssat} = \frac{W}{L} \cdot C'_{ox} U_T^2 \cdot (n - 1) \cdot e^{(V_{gs} - V_{th})/nU_T}$$

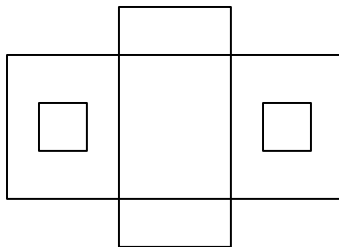
- Transistor

$$I_{dssat} = \frac{k}{2} (V_{gs} - V_{th})^2$$

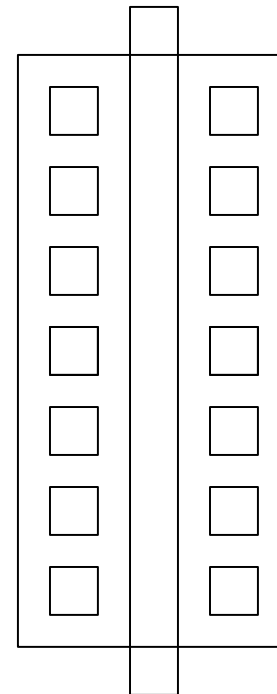
$$g_m = \sqrt{k I_{dssat} (W / L)}$$

$$I_{dssat} = \text{const} \cdot e^{(V_{gs} - V_{th}) / n U_T}$$

$$g_m = I_{dssat} / n U_T$$

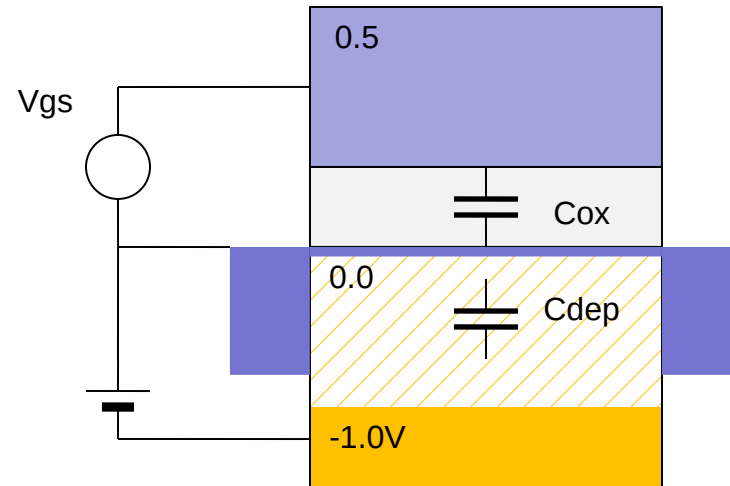


$$g_m = \sqrt{k I_{dssat} (W / L)}$$

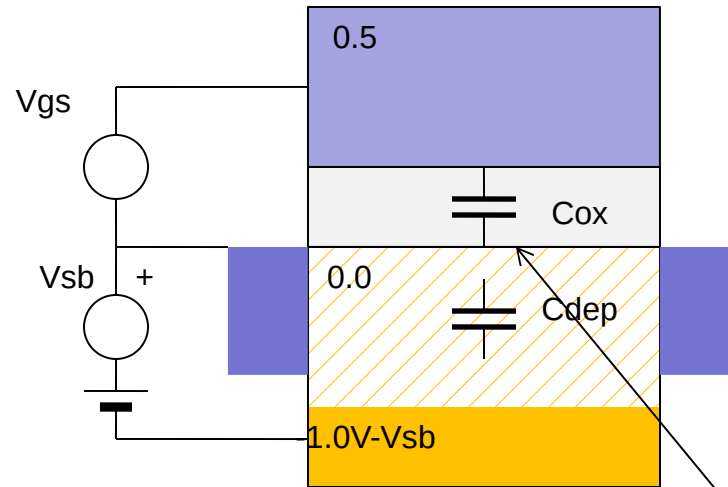


$$g_m = I_{dssat} / n U_T$$

- Transistor

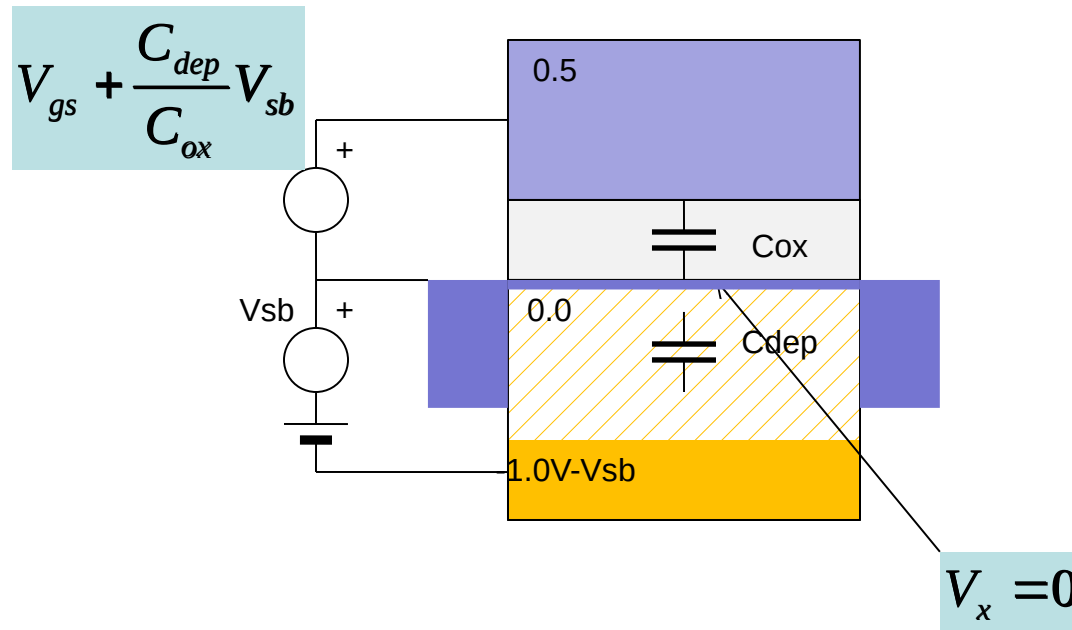


- Transistor



$$V_x = - \frac{C_{dep}}{C_{dep} + C_{ox}} V_{sb}$$

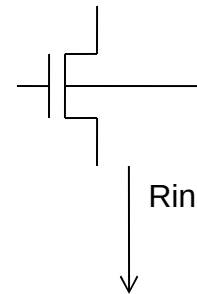
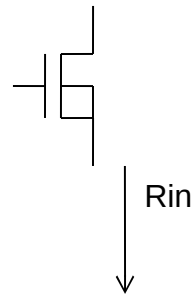
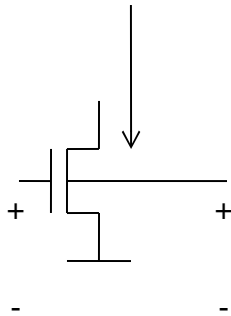
- Transistor



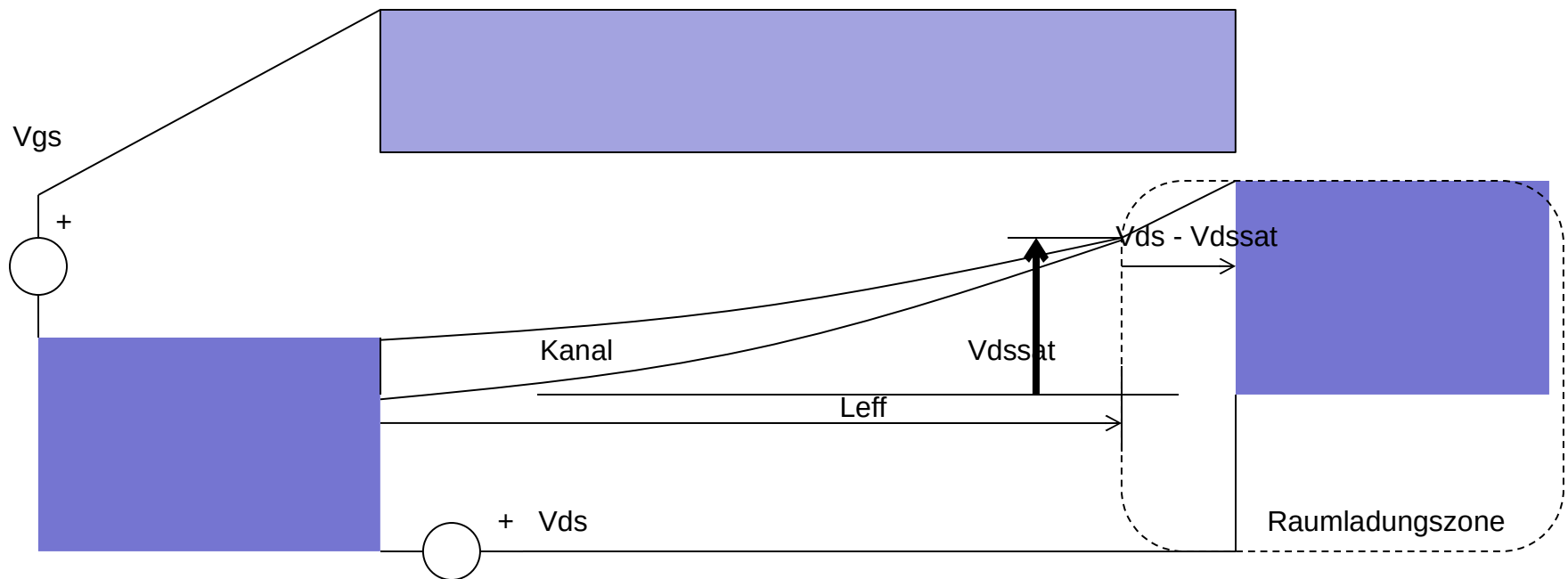
- Transistor

$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} - V_{th0} - 0.5V_{sb})^2$$

$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} + 0.5V_{sb} - V_{th0})^2$$



- Die Größe der Raumladungszone hängt von der Überspannung $V_{ds} - V_{dssat}$



• ...

$$I_{dssat} = \frac{1}{2} \mu C'_{ox} \frac{W}{L} (V_{gs} - V_{th})^2$$

$$I_{ds} (V_{ds} - V_{dssat}) = I_{dssat} + \frac{\partial I_{dssat}}{\partial L} \Delta L (V_{ds} - V_{dssat})$$

Reihenentwicklung

$$I_{ds} (V_{ds} - V_{dssat}) = I_{dssat} \left(1 + \frac{\Delta L}{L}\right)$$

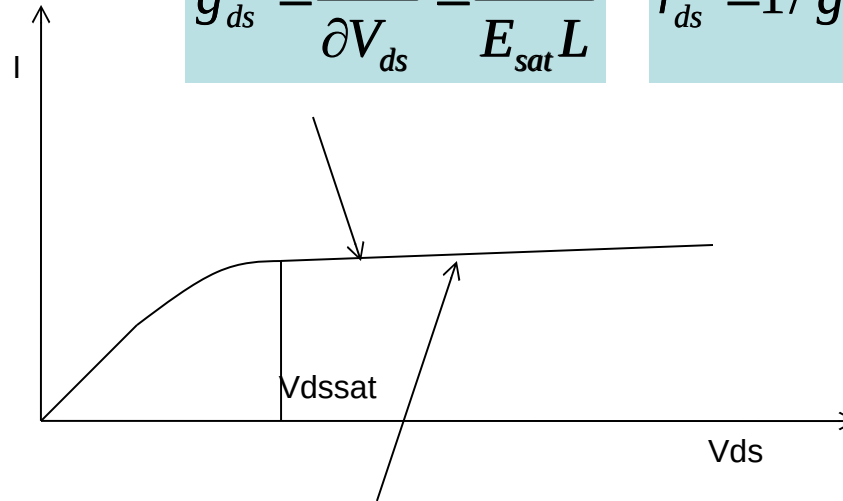
Annahme

$$\Delta L \sim (V_{ds} - V_{dssat}) / E_{sat}$$



$$I_{ds} = I_{dssat} \left(1 + (V_{ds} - V_{dssat}) / E_{sat} L\right)$$

• ...



$$g_{ds} = \frac{\partial I_{ds}}{\partial V_{ds}} = \frac{I_{dssat}}{E_{sat} L}$$

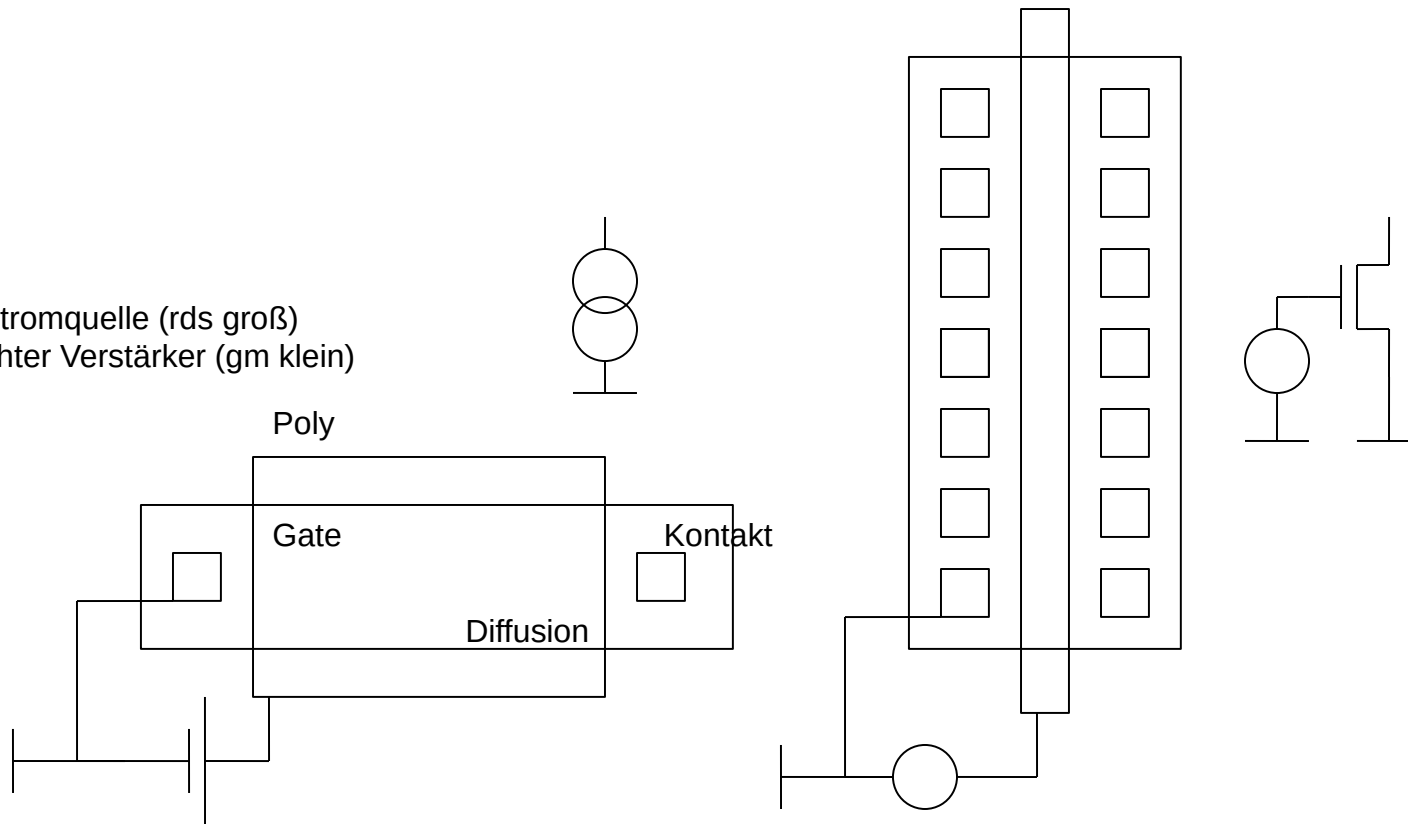
$$r_{ds} = 1 / g_{ds} = \frac{E_{sat} L}{I_{dssat}}$$

$$I_{ds} = I_{dssat} (1 + (V_{ds} - V_{dssat}) / E_{sat} L)$$

• ...

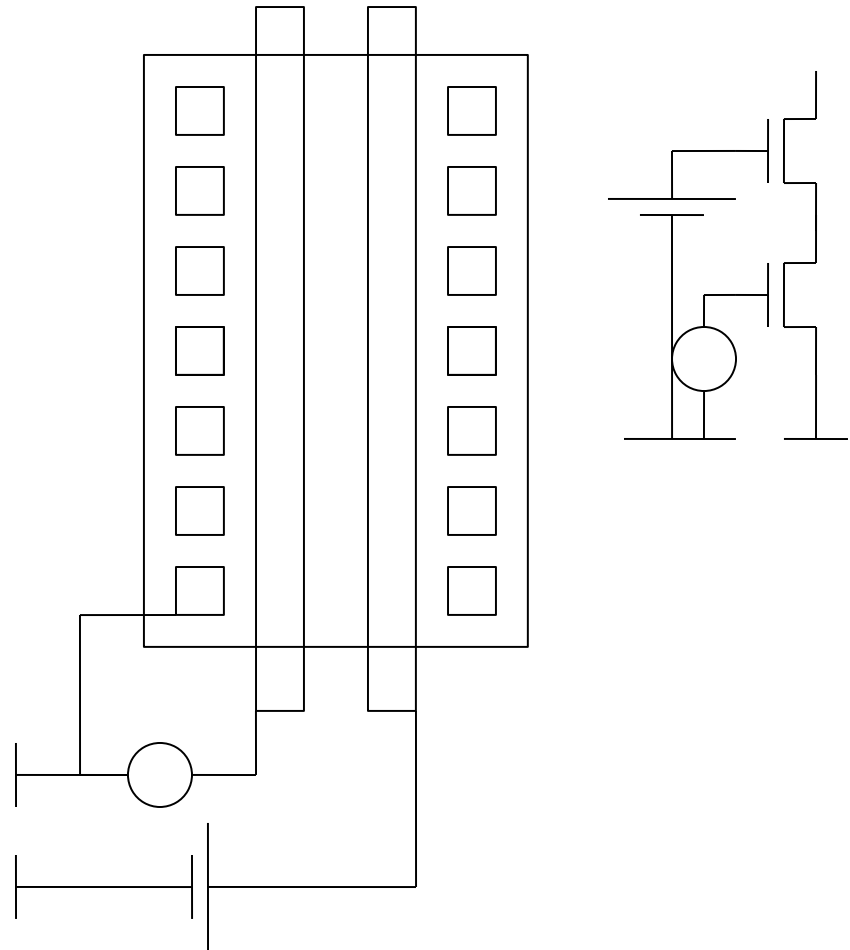
L klein
Schlechte Stromquelle (r_{ds} klein)
Guter Verstärker (g_m groß)

L groß
Gute Stromquelle (r_{ds} groß)
Schlechter Verstärker (g_m klein)

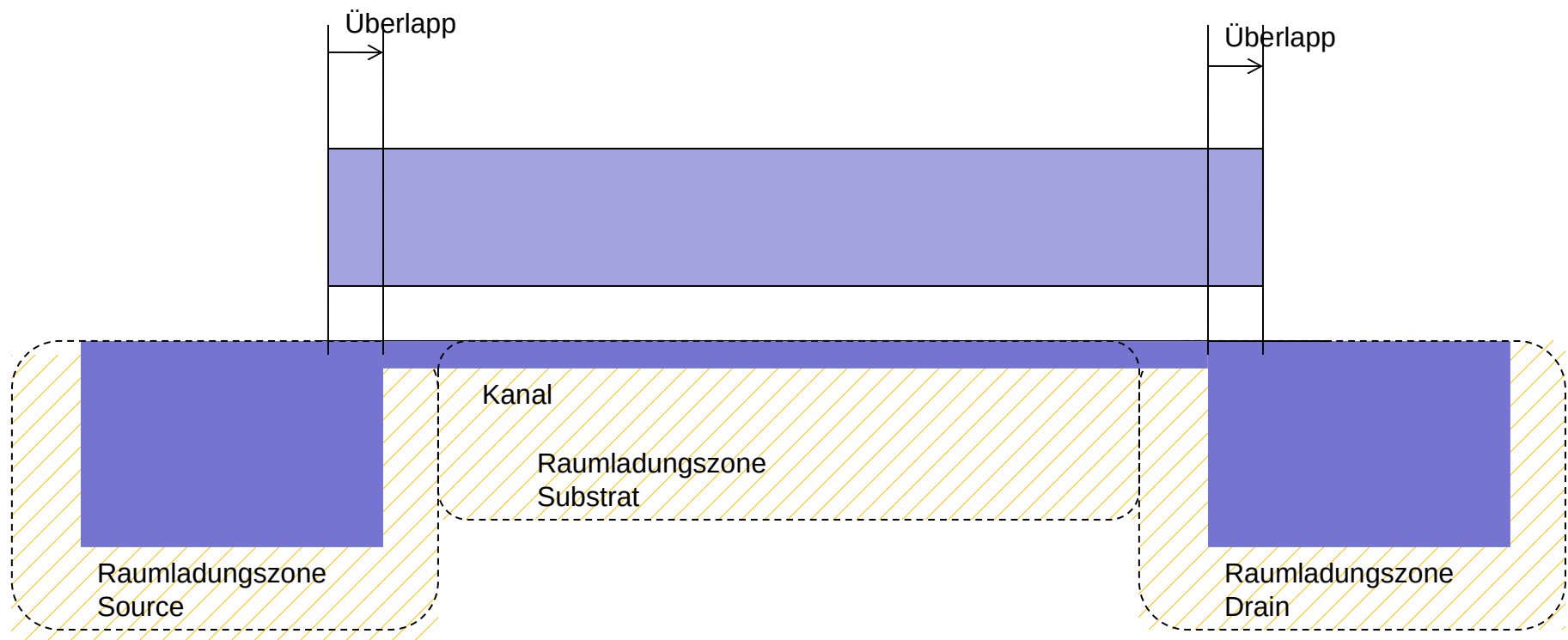


- ...

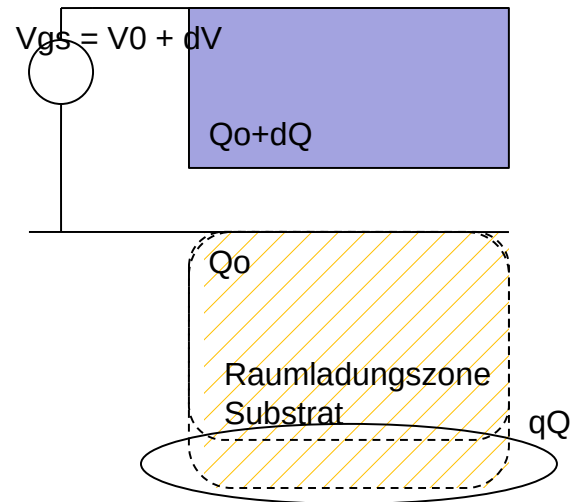
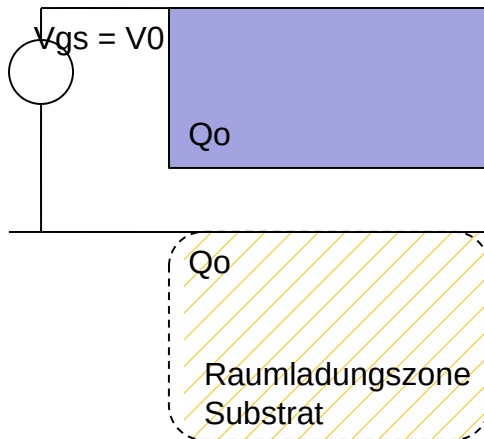
Kaskode (wird später erklärt)
Gute Stromquelle (rout groß)
Guter Verstärker (g_m groß)



- In der Transistorstruktur haben wir an mehreren Stellen Raumladung



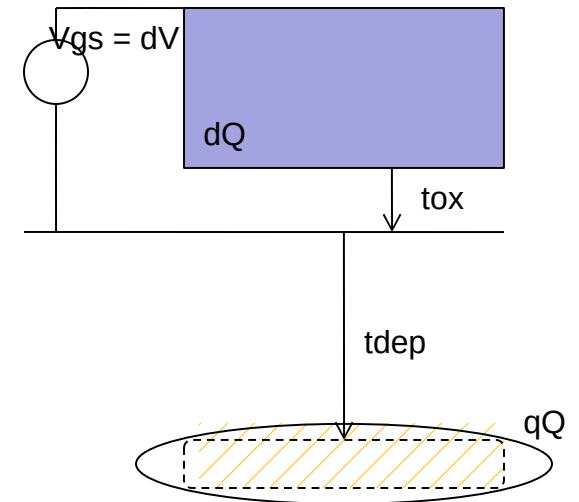
- Dynamische Kapazitäten



$$C_{dynamic} = dQ/dV$$

$$C_{dep_dyn} = \epsilon_{silicon}/t_{dep}$$

Nächste Folie



• ...

$$\frac{dQ}{dV} = C_{dyn}$$

$$C_{dyn} = \frac{\epsilon}{t}$$

$$Q = \text{const} \cdot t$$

$$C_{dyn} = \text{const} / Q$$

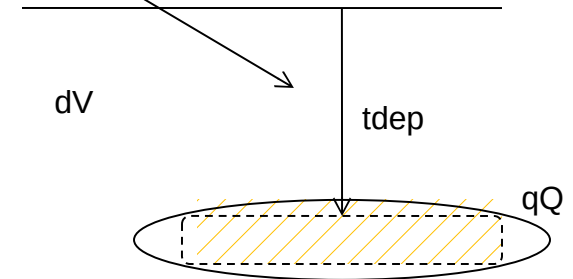
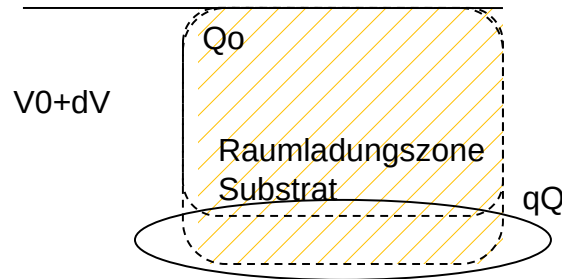
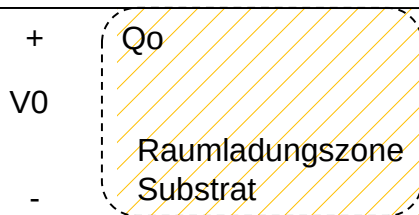
$$\frac{dQ}{dV} = \text{const} / Q$$

$$Q dQ = \text{const} \cdot dV$$

$$\frac{1}{2} Q^2 = \text{const} \cdot V$$

$$Q = \sqrt{2 \cdot \text{const} \cdot V}$$

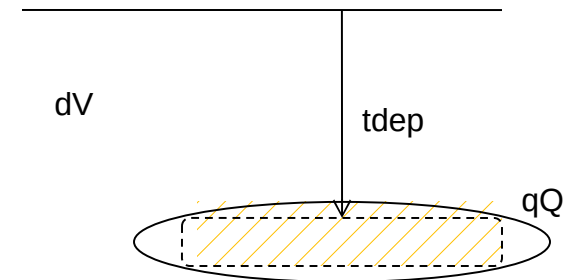
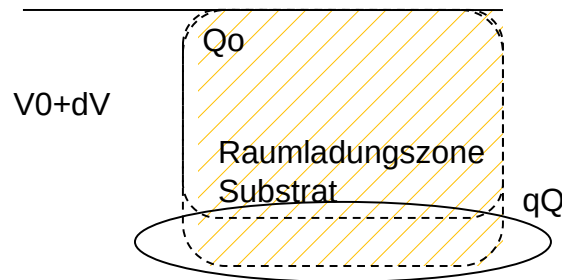
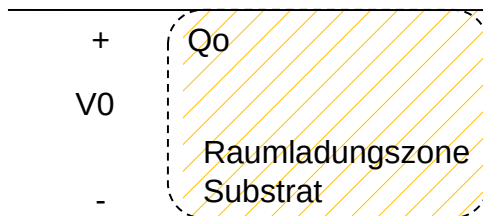
$$C_{dyn} = \frac{dQ}{dV} = \frac{d(\sqrt{2 \cdot \text{const} \cdot V})}{dV} = \frac{\sqrt{2 \cdot \text{const} \cdot V}}{2\sqrt{V}} = \frac{1}{2} \frac{Q}{V}$$



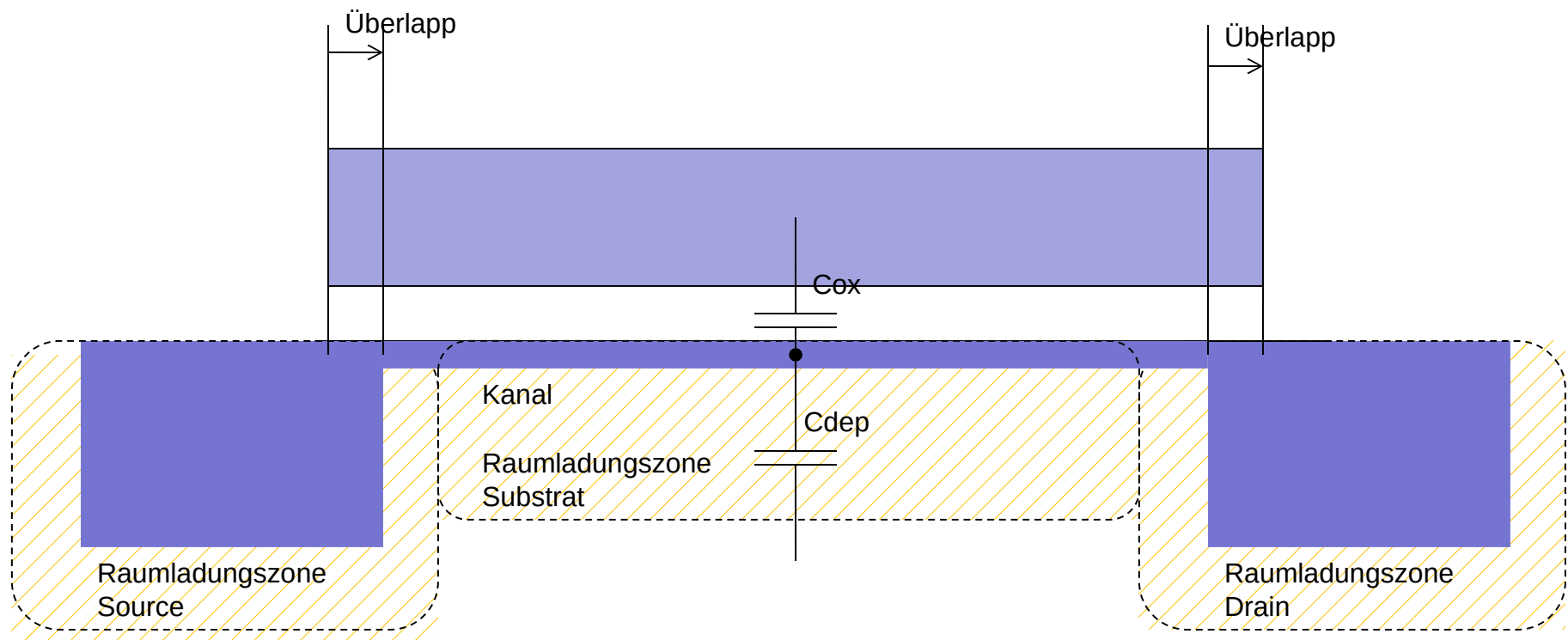
- Dicke der Raumladungszone und deren Ladung hängen als Quadratwurzel von der Spannung in der Zone V
- Die Ladung der Zone ist durch die Formel $2 \cdot C_{dyn} \cdot V$ gegeben
- Man kann näherungsweise C_{dyn} anstatt normaler Kapazität verwenden
- Wir haben deshalb überall C_{dep_dyn} verwendet

$$Q = \sqrt{2 \cdot \text{const} \cdot V}$$

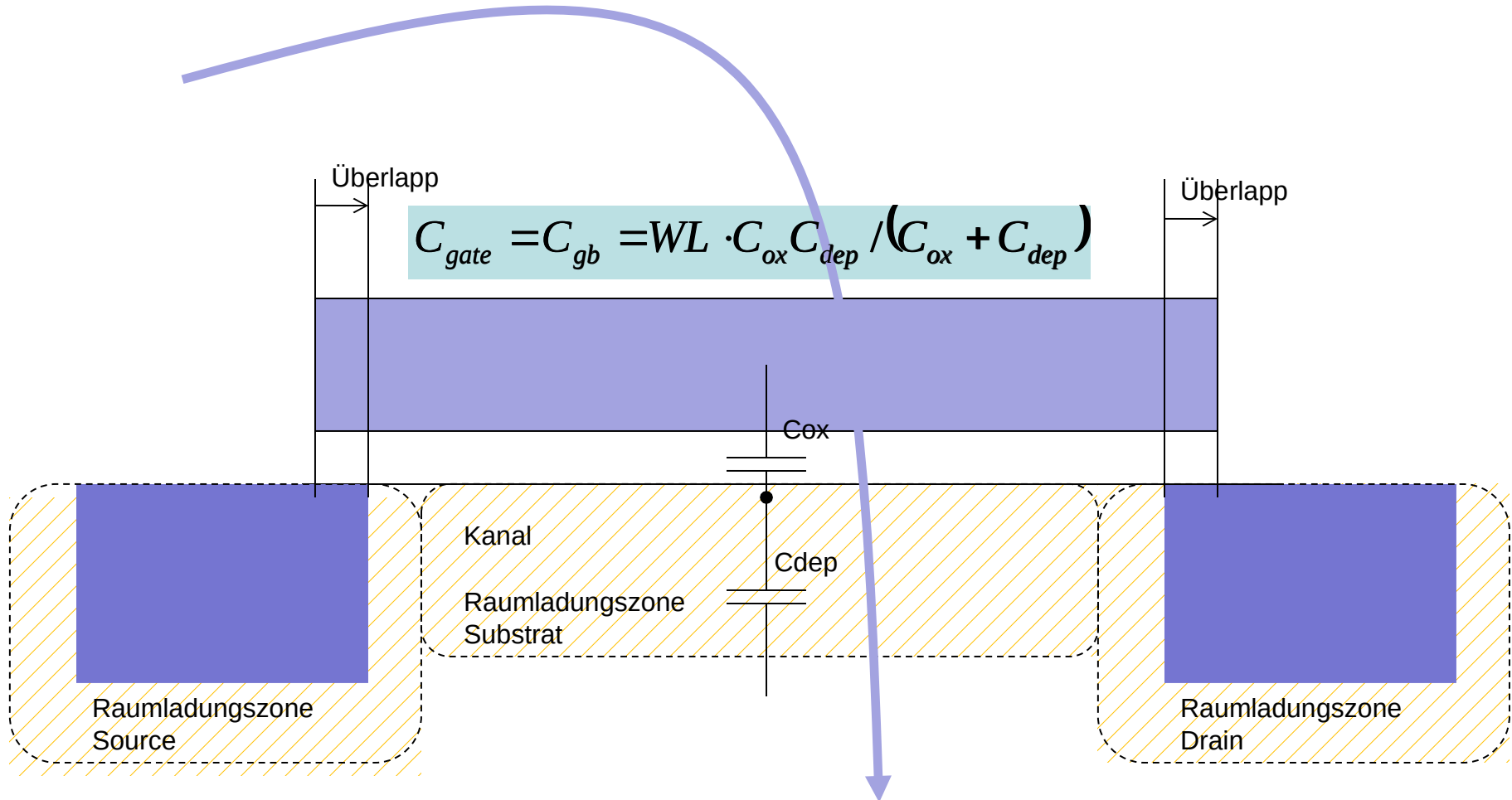
$$2C_{dyn}V = Q$$



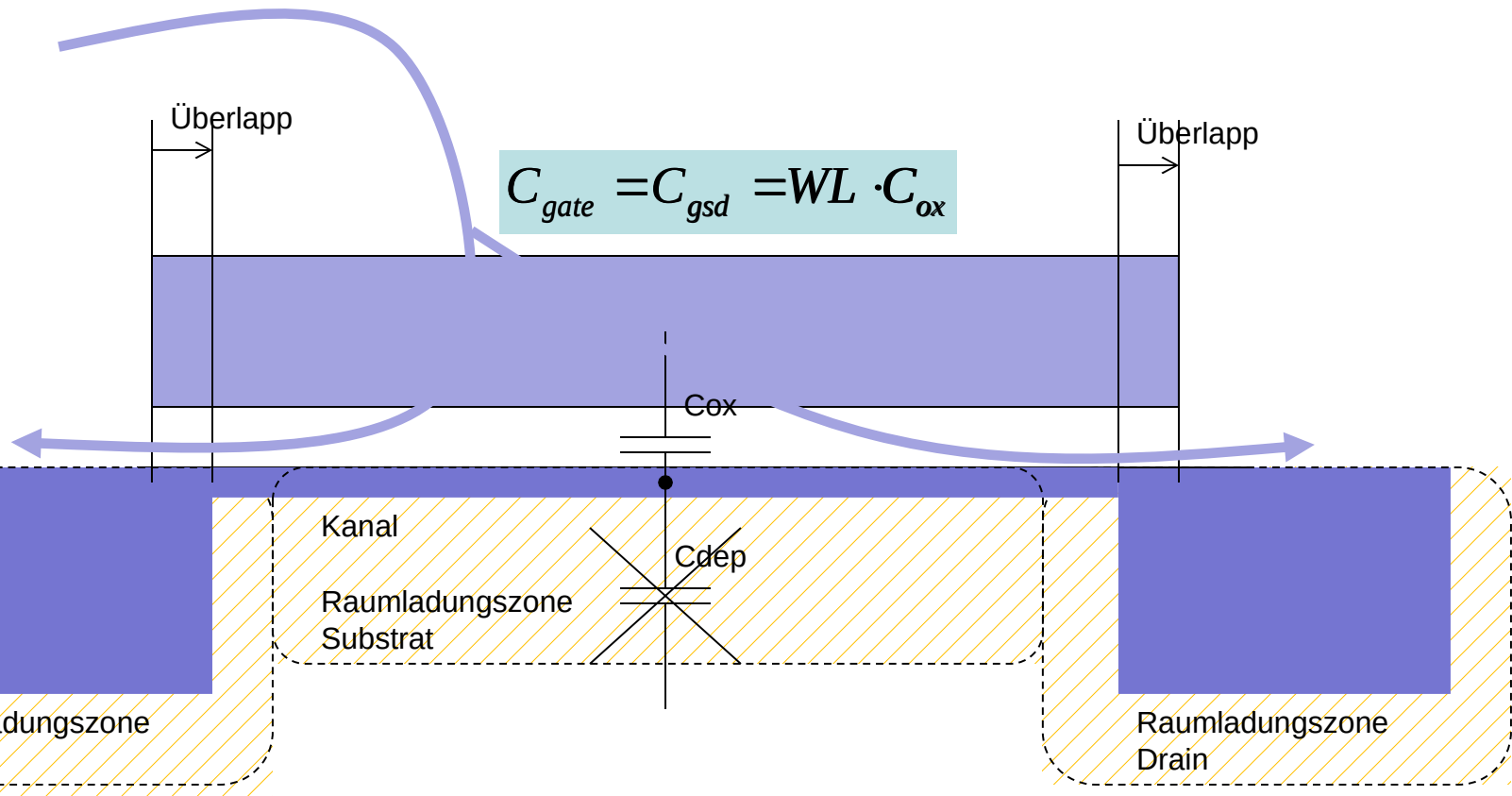
- Oxidkapazität $C_{ox} * W * L$
- Kapazität der Verarmungszone $C_{dep} * W * L$



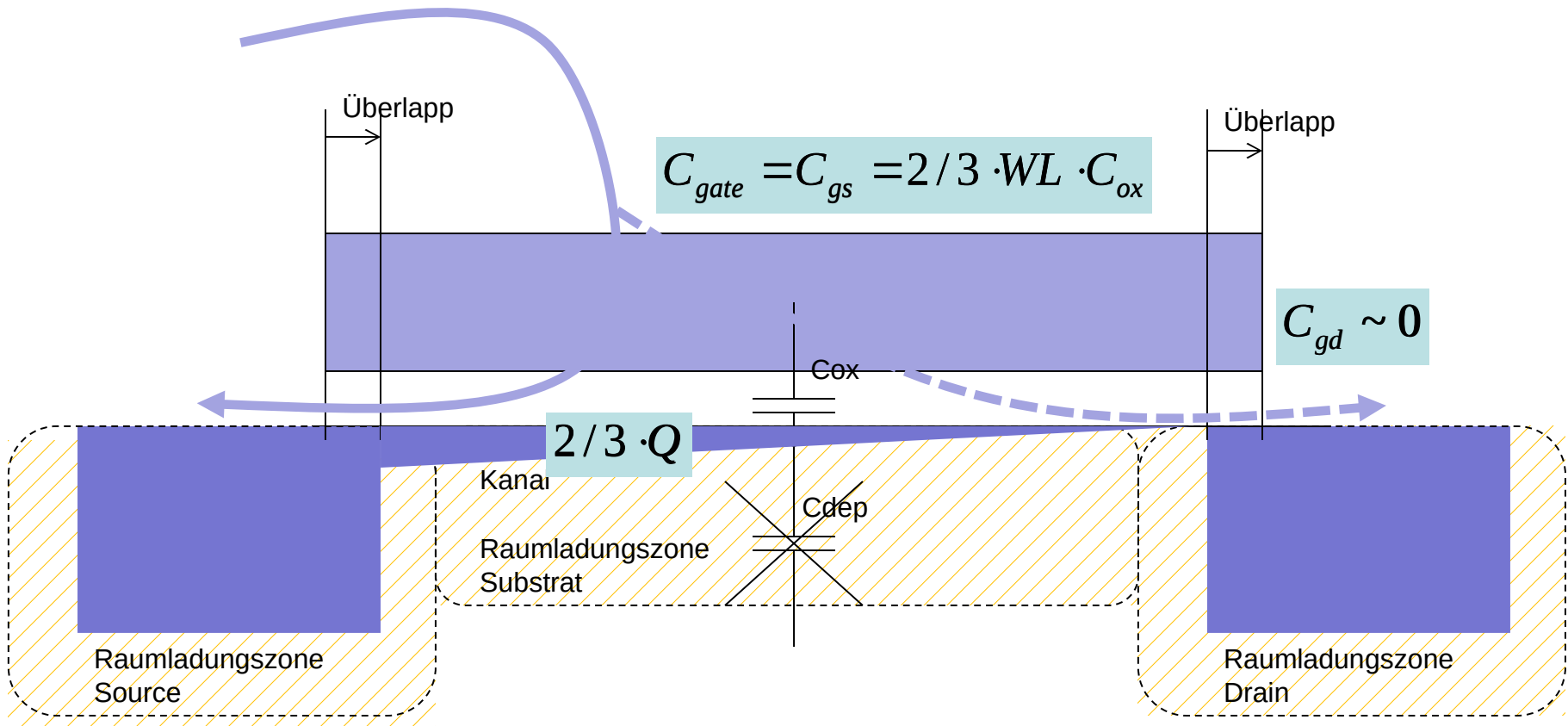
- Die Gate Kapazität ist die Reihenschaltung von C_{ox} und C_{dep}
- Die Kapazität wirkt zwischen dem Gate und dem Substrat



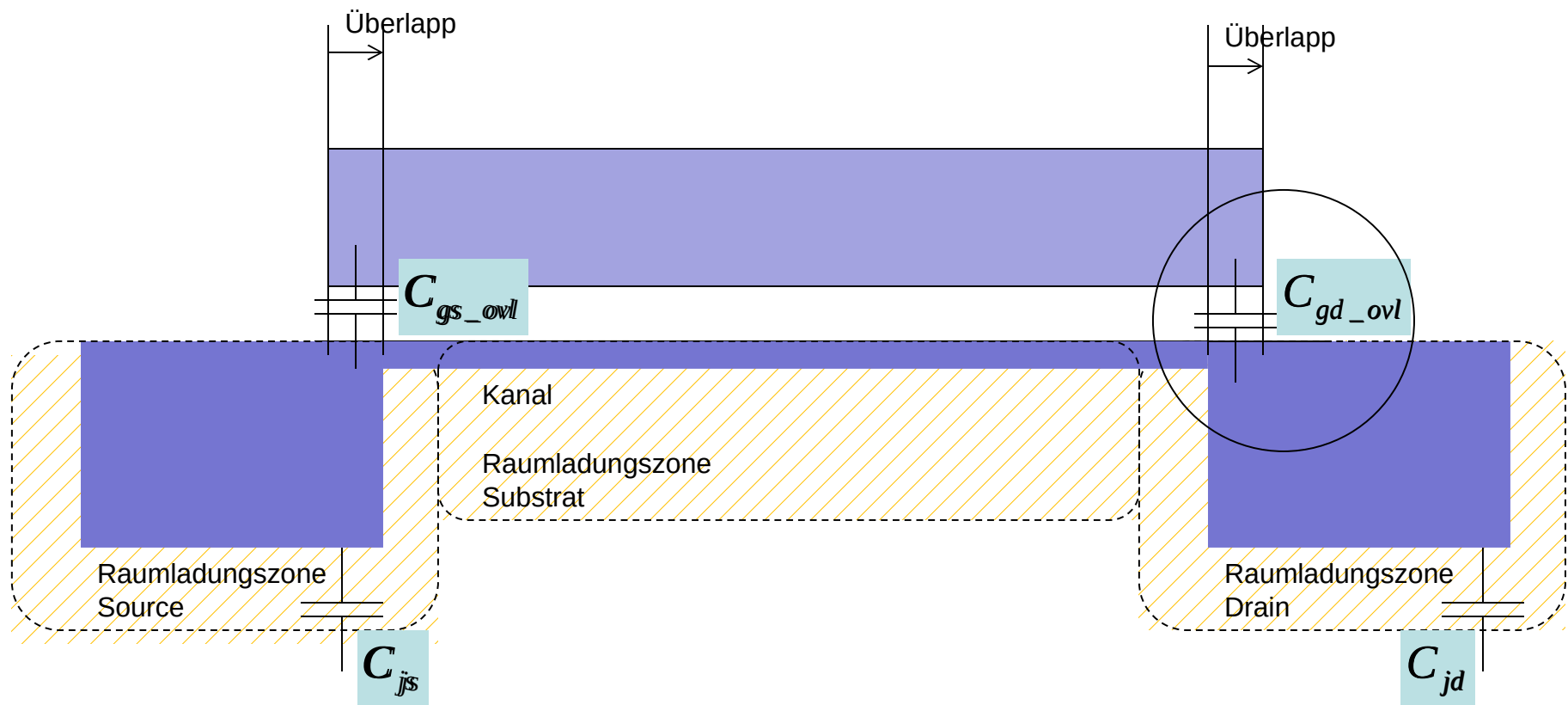
- Die Spannung zwischen den Kontakten von Cdep ist fest
- Die Gate-Kapazität ist also größer als in schwacher Inversion
- Gate-Kapazität wirkt zwischen dem Gate und Source und Drain gleichmäßig



- Da der Kanal in Sättigung von Drain abgekoppelt ist, wirkt die Kapazität nur zwischen Gate und Source
- In erster Näherung keine Kapazität zwischen dem Drain und Gate



- PN Übergang Kapazitäten (junction Kapazitäten)
- Überlappkapazitäten C_{gs_ovl} und C_{gd_ovl}



• ...

